1. General description

The 74HC03-Q100; 74HCT03-Q100 is a quad 2-input NAND gate with open-drain outputs. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of $V_{\rm CC}$.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Input levels:
 - For 74HC03-Q100: CMOS level
 - For 74HCT03-Q100: TTL level
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

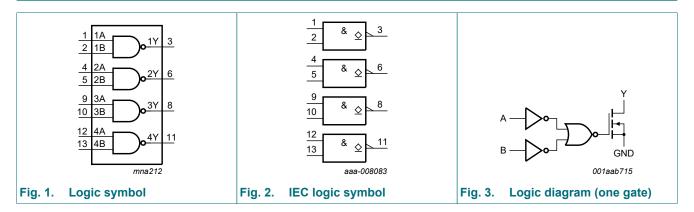
3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | |
|---------------------------------|-------------------|---------|---------------------------------------------------------------------------|----------|--|
| | Temperature range | Name | Description | Version | |
| 74HC03D-Q100 74HCT03D-Q100 | -40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 | |
| 74HC03PW-Q100 74HCT03PW-Q100 | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 | |

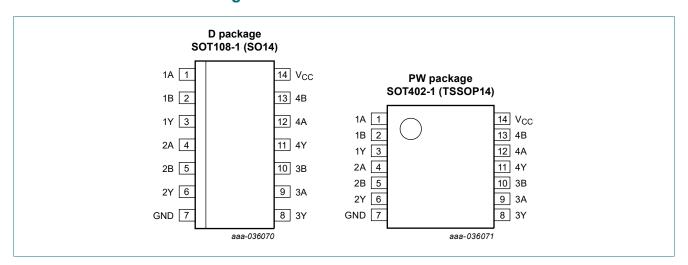


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------|----------------|
| 1A, 2A, 3A, 4A | 1, 4, 9, 12 | data input |
| 1B, 2B, 3B, 4B | 2, 5, 10, 13 | data input |
| 1Y, 2Y, 3Y, 4Y | 3, 6, 8, 11 | data output |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ Z = high-impedance \ OFF-state.$

| Input | Output | |
|-------|--------|----|
| nA | nB | nY |
| L | L | Z |
| L | Н | Z |
| Н | L | Z |
| Н | Н | L |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|-------------------------------------------------------------|-----|------|------|------|
| V_{CC} | supply voltage | | | -0.5 | +7 | V |
| Vo | output voltage | | [1] | -0.5 | +7 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | [1] | - | ±20 | mA |
| I _{OK} | output clamping current | V _O < -0.5 V | [1] | - | -20 | mA |
| Io | output current | -0.5 V < V _O | | - | -25 | mA |
| I _{CC} | supply current | | | - | 50 | mA |
| I _{GND} | ground current | | | -50 | - | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| P _{tot} | total power dissipation | | [2] | - | 500 | mW |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | ameter Conditions | | 74HC03-Q100 | | | 74HCT03-Q100 | | |
|------------------|-------------------------------------|-------------------------|-----|-------------|-----------------|-----|--------------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| Vo | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 2.0 V | - | - | 625 | - | - | - | ns/V |
| | | V _{CC} = 4.5 V | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | V _{CC} = 6.0 V | - | - | 83 | - | - | - | ns/V |

^[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol Parameter | | Conditions | 25 °C | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit | |
|------------------|---------------------------|---------------------------------------------------------------------|-------|------|------------------|------|-------------------|------|------|----|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC03 | Q100 | | | | | | | | 1 | |
| input voltage | | V _{CC} = 2.0 V | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | | V _{CC} = 4.5 V | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | V _{CC} = 6.0 V | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V _{IL} | LOW-level | V _{CC} = 2.0 V | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | input voltage | V _{CC} = 4.5 V | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | V _{CC} = 6.0 V | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V _{OL} | LOW-level | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | output voltage | I _O = 20 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | ٧ |
| | | I _O = 4.0 mA; V _{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | ٧ |
| | | I _O = 5.2 mA; V _{CC} = 6.0 V | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 6.0 V | - | 0.1 | - | - | ±1 | - | ±1 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IL}$; $V_{CC} = 6.0 \text{ V}$; $V_O = V_{CC}$ or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$ | - | 2.0 | - | - | 20 | - | 40 | μA |
| C _I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |
| 74HCT0 | 3-Q100 | ' | | | | 1 | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | - | 8.0 | - | 0.8 | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | Ι _Ο = 20 μΑ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | ٧ |
| | | I _O = 4.0 mA | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | ٧ |
| l _l | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | ±0.1 | - | ±1 | - | ±1 | μΑ |
| l _{OZ} | OFF-state output current | $V_I = V_{IL}$; $V_{CC} = 5.5 V$; $V_O = V_{CC}$ or GND | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$ | - | - | 2.0 | - | 20 | - | 40 | μΑ |
| ΔI _{CC} | additional supply current | onal per input pin; | | 100 | 360 | - | 450 | - | 490 | μΑ |
| Cı | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; C_L = 50 pF; for test circuit, see Fig. 5.

| Symbol | Parameter Conditions | | | | 25 °C | | -40 °C to +85 °C | -40 °C to +125 °C | Unit |
|--------------------------------|-------------------------------|------------------------------------------------------|-----|---|-------|-----|---------------------|----------------------|------|
| | | | | | Тур | Max | Max | Max | |
| 74HC03- | -Q100 | | | | | | | | |
| t _{pd} | propagation | nA, nB to nY; see Fig. 4 | [1] | | | | | | |
| | delay | V _{CC} = 2.0 V | | - | 28 | 95 | 120 | 145 | ns |
| | | V _{CC} = 4.5 V | | - | 10 | 19 | 24 | 29 | ns |
| | | V _{CC} = 5.0 V; C _L = 15 pF | | - | 8 | - | - | - | ns |
| | | V _{CC} = 6.0 V | | - | 8 | 16 | 20 | 25 | ns |
| t _t transition time | | see Fig. 4 | [2] | | | | | | |
| | | V _{CC} = 2.0 V | | - | 19 | 75 | 95 | 110 | ns |
| | | V _{CC} = 4.5 V | | - | 7 | 15 | 19 | 22 | ns |
| | | V _{CC} = 6.0 V | | - | 6 | 13 | 16 | 19 | ns |
| C _{PD} | power dissipation capacitance | per package; V _I = GND to V _{CC} | [3] | - | 4 | - | - | - | pF |
| 74HCT0 | 3-Q100 | | | | | | 1 | | |
| t _{pd} | propagation | nA, nB to nY; see Fig. 4 | [1] | | | | | | |
| | delay | V _{CC} = 4.5 V | | - | 12 | 24 | 30 | 36 | ns |
| | | V _{CC} = 5.0 V; C _L = 15 pF | | - | 10 | - | - | - | ns |
| t _t | transition time | V _{CC} = 4.5 V; see <u>Fig. 4</u> [2] | | - | 7 | 15 | 19 | 22 | ns |
| C _{PD} | power dissipation capacitance | per package; $V_I = GND$ to $V_{CC} - 1.5 V$ [3] | | - | 4 | - | - | - | pF |

^[1] t_{pd} is the same as t_{PLZ} and t_{PZL} .

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_i \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

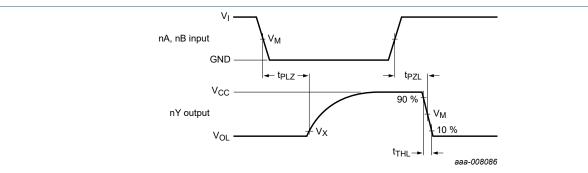
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching; $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

^[2] t_t is the same as t_{THL} . [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

10.1. Waveforms and test circuit



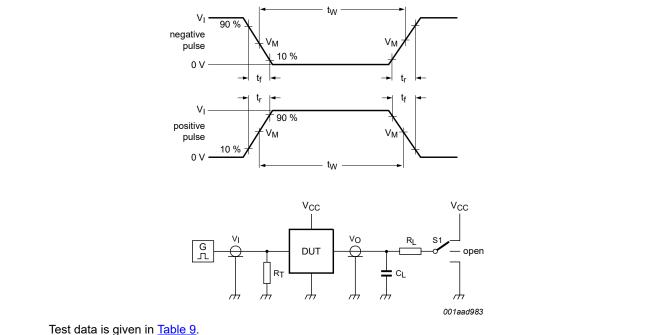
Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Input to output propagation delays Fig. 4.

Table 8. Measurement points

| Туре | Input | Output | | |
|--------------|-----------------------|-----------------------|-----------------------|--|
| | V _M | V _M | V _X | |
| 74HC03-Q100 | 0.5 × V _{CC} | 0.5 × V _{CC} | 0.1 × V _{CC} | |
| 74HCT03-Q100 | 1.3 V | 1.3 V | 0.1 × V _{CC} | |



Definitions test circuit:

 R_T = termination resistance should be equal to output impedance Z_0 of the pulse generator;

 C_L = load capacitance including jig and probe capacitance.

Fig. 5. Test circuit for measuring switching times

Table 9. Test data

| Туре | Input | | Load | S1 position | |
|--------------|-----------------|---------------------------------|--------------|-------------|-------------------------------------|
| | Vı | t _r , t _f | CL | R_L | t _{PZL} , t _{PLZ} |
| 74HC03-Q100 | V _{CC} | 6 ns | 15 pF, 50 pF | 1 kΩ | V _{CC} |
| 74HCT03-Q100 | 3.0 V | 6 ns | 15 pF, 50 pF | 1 kΩ | V _{CC} |

74HC_HCT03_Q100

11. Package outline

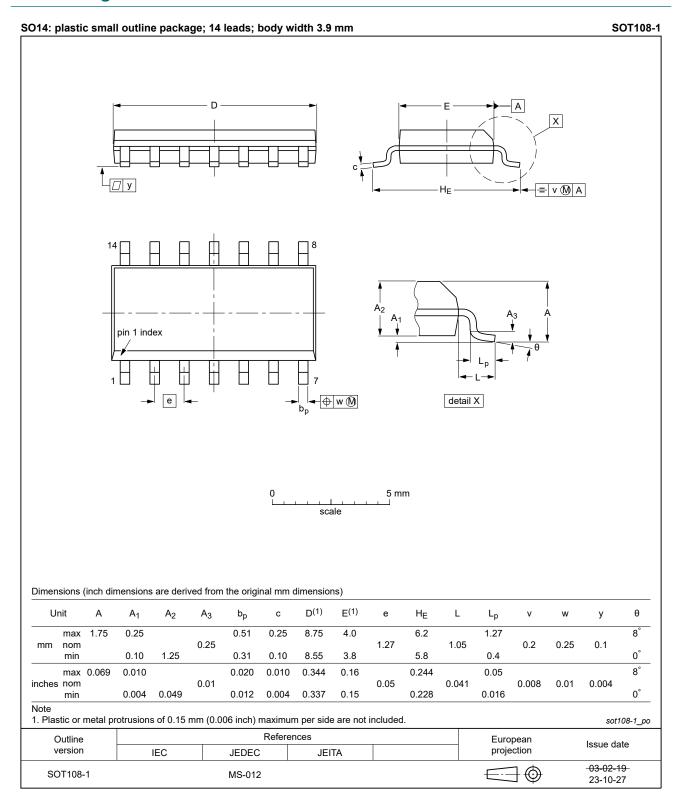


Fig. 6. Package outline SOT108-1 (SO14)

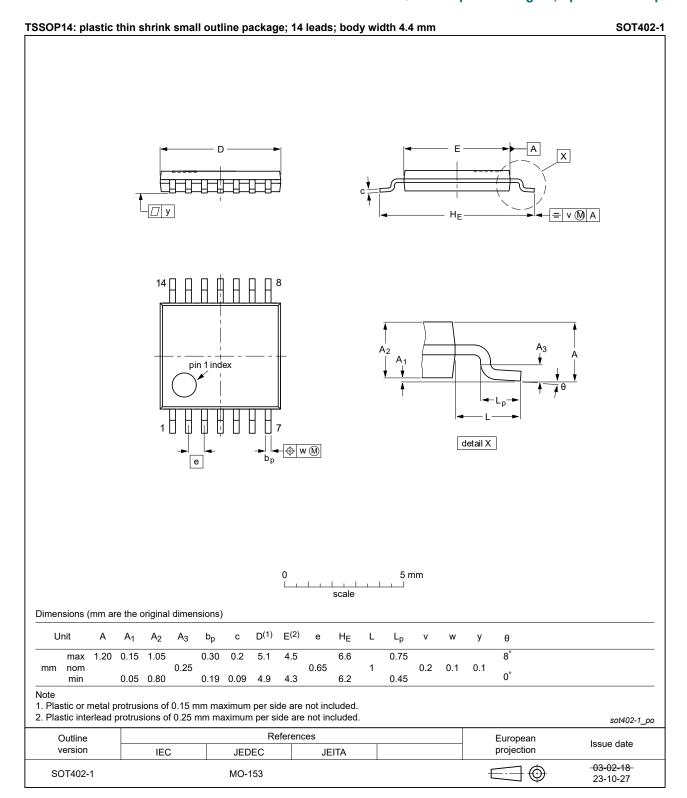


Fig. 7. Package outline SOT402-1 (TSSOP14)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description | |
|---------|---------------------------------------|--|
| CDM | Charged Device Model | |
| CMOS | mplementary Metal-Oxide Semiconductor | |
| DUT | Device Under Test | |
| ESD | ElectroStatic Discharge | |
| HBM | uman Body Model | |
| TTL | Transistor-Transistor Logic | |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|---------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|---------------|---------------------|--|--|
| 74HC_HCT03_Q100 v.4 | 20240216 | Product data sheet | - | 74HC_HCT03_Q100 v.3 | | |
| Modifications: | Section 2: ESD specification updated according to the latest JEDEC standard. Fig. 6, Fig. 7: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153 | | | | | |
| 74HC_HCT03_Q100 v.3 | 20210810 | Product data sheet | - | 74HC_HCT03_Q100 v.2 | | |
| Modifications: | Section 2 up | odated. | | | | |
| 74HC_HCT03_Q100 v.2 | 20210107 | Product data sheet | - | 74HC_HCT03_Q100 v.1 | | |
| Modifications: | The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type numbers 74HC03DB-Q100, 74HCT03DB-Q100 (SOT337-1 / SSOP14) removed. Section 7: Derating values for Ptot total power dissipation have been updated. | | | | | |
| 74HC_HCT03_Q100 v.1 | 20130704 | Product data sheet | - | - | | |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---------------------------------------------------------------------------------------|
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